

Formation of mixed TiC/Al₂O₃ layers and α - and κ -Al₂O₃ on cemented carbides by chemical vapour deposition

C. COLOMBIER*, B. LUX

Institute for Chemical Technology of Inorganic Materials, Technical University Vienna, Getreidemarkt 9, A-1060 Vienna, Austria

Al₂O₃ and Ti(C, O) were codeposited as a mixed chemical vapour deposition (CVD) layer from AlCl₃-TiCl₄-CH₄-CO₂-H₂ gas mixtures on cemented carbides and pure alumina substrates. A thermodynamical approach of this CVD system is presented. The coatings were described by SEM and X-ray diffraction analysis. They consist of large faceted α -Al₂O₃ crystals containing some titanium and surrounded by a fine grained Ti(C, O) matrix. Carbon diffusing from the cemented carbide substrate can considerably influence the morphology and the composition of the mixed coating.

Methane in a AlCl₃-CO₂-H₂ environment stabilizes the κ -Al₂O₃ phase which can be deposited as a compact layer without whisker formation on a WC-Co substrate even without a TiC underlayer.

1. Introduction

Today, most cemented carbide tools for steel cutting are coated with thin layers (up to 10 μ m) of refractory materials e.g. TiC, TiN, Ti(C, N), Al₂O₃, HfN, etc., in order to improve their wear resistance [1]. Many of these coatings are applied as multilayers, i.e. a succession of layers of different materials one above the other permitting optimization of the coating's technological properties. One important feature of multilayers alternating several TiC, Al₂O₃ or TiN layers is their particularly fine grain size, independent of the overall coating thickness. Fig. 1 gives an example of coatings similar in thickness and chemical composition but very different in their morphology. In both cases the coating consists mainly of alumina deposited on a cemented carbide substrate. In the first case (Fig. 1a) the coarse Al₂O₃ crystals grew during a normal chemical vapour deposition (CVD). In the second case (Fig. 1b) the Al₂O₃ growth was disrupted by a very thin TiC layer resulting in a substantial grain refinement in the Al₂O₃ layer. Fine grained coatings can be particularly advantageous for certain metal cutting applications as far as tool life and performance are concerned.

The aim of this work is to study in more detail the possibilities of combining two refractory materials within a coating in a different way. This will not be done as a "multilayer" but as a "mixed layer", i.e. the deposition of both phases occurs simultaneously side by side in a compacted layer.

Such CVD codeposition systems have already been described in the literature. For example Stinton *et al.* [2] deposited SiC-TiSi₂ "ceramic-ceramic composite

layers" and Hirai *et al.* [3] mixed Si₃N₄-BN coatings. The thermodynamics of the latter CVD system was studied in detail by Besmann [4]. Such calculations, used instead of the experimental trial-and-error methods, allow a considerable reduction in the experimental effort which can then be devoted to the kinetics of CVD reactions only.

2. Thermodynamic approach

Thermodynamic calculations based on the minimization of the total Gibbs free energy of a system were carried out using the computer programs "Freemin" and "Ekvicalc" [5]. In accordance with earlier experimental deposition conditions, calculations were performed for 1050°C and 65 mbar only for the systems containing aluminium, titanium, oxygen, carbon, chlorine and hydrogen.

More than 40 condensed phases and 120 gases were considered. The results are represented in Fig. 2 as thermodynamic yields of the deposited solid phases TiC, Al₂O₃, C, Ti₂O₃ and Ti₃O₅ according to the following equations

$$Y(\text{TiC}) = \frac{\text{mole TiC equil}}{\text{mole TiCl}_4 \text{ inlet}} \cdot 100$$

$$Y(\text{Al}_2\text{O}_3) = 2 \cdot \frac{\text{mole Al}_2\text{O}_3 \text{ equil}}{\text{mole AlCl}_3 \text{ inlet}} \cdot 100$$

$$Y(\text{C}) = \frac{\text{mole C equil}}{\text{mole CH}_4 \text{ inlet}} \cdot 100$$

$$Y(\text{Ti}_2\text{O}_3) = 2 \cdot \frac{\text{mole Ti}_2\text{O}_3 \text{ equil}}{\text{mole TiCl}_4 \text{ inlet}} \cdot 100$$

* Present address: Atochem, Centre de Recherche Rhône Alpes, Bp 20, F-69310 Pierre-Bénite, France.

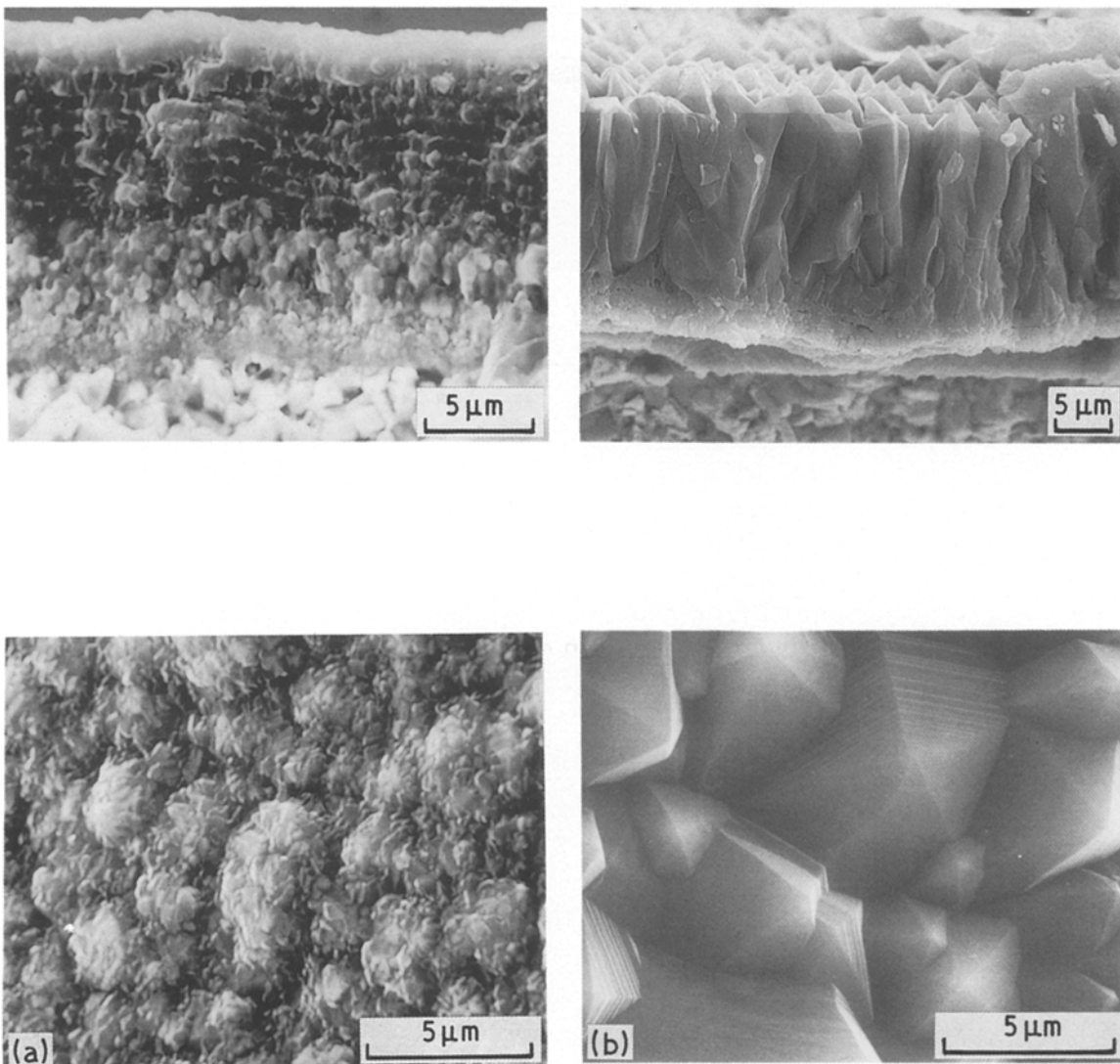


Figure 1 Comparison of the grain size in thick alumina CVD coatings deposited on WC-Co-TiC substrates. (a) Al₂O₃-TiC multilayer. The alumina deposition was briefly interrupted by a thin TiC deposition made without flushing the reactor wall between the two CVD processes. The result was a very fine grained Al₂O₃ coating. (b) Pure Al₂O₃ layer. As is generally the case in CVD systems applied to uniform crystalline layers, the crystallites grew in size during deposition because of the low nucleation frequency. The coating has a columnar structure with large alumina crystallites.

$$Y(\text{Ti}_3\text{O}_5) = 3 \cdot \frac{\text{mole Ti}_3\text{O}_5 \text{ equil}}{\text{mole TiCl}_4 \text{ inlet}} \cdot 100$$

Fig. 2 shows the influence of the AlCl₃, CH₄ and CO₂ concentrations in the gas phase on the solid deposits as obtained by the calculations. In the absence of CH₄, deposition of Ti₂O₃ can be avoided at AlCl₃ concentrations greater than 1.8 mol %. In the absence of AlCl₃ the Ti₂O₃ deposition should not occur if the CH₄ concentration exceeds 3.7 mol %. At high AlCl₃ and CH₄ concentrations (3 and 6 mol % respectively) the CO₂ concentration has to be low enough (less than 7.7 mol %) to prevent Ti₃O₅ formation.

It must be noted however that these calculations were performed assuming formation of pure solid phases. The solubility of elements in solids, i.e. mixed crystal formations such as Ti(C, O), etc., could not be considered with the computer program.

3. Experimental methods

3.1. CVD procedures

In a small CVD apparatus (Fig. 3) gas mixtures of TiCl₄, AlCl₃, CH₄, CO₂ and H₂ could be produced.

TiCl₄ was evaporated and AlCl₃ was prepared *in situ* by reacting dried HCl with hot aluminium chips (350°C), both at a pressure of one atmosphere. Seven samples could be simultaneously coated in the "hot Wall" reactor. For the exact arrangement of the reactor chamber [6]. All CVD experiments were carried out for 1 h at 65 mbar total pressure and 1050°C. The flow rate was 40 l h⁻¹ (diameter) of the reactor tube: 2.5 cm). The composition of the gas phase for each experiment is indicated in Table I.

In accordance with the results of the thermodynamic study, high AlCl₃ concentrations (3 mol %) and high CH₄ concentrations (6 mol %) were chosen in order to avoid titanium oxide formation. As already discussed by Vandelbulk [7], due to the slow kinetics of the methane decomposition, even at CH₄ concentrations above 3.7 mol % in the gas phase, no carbon deposition occurred.

The most important variable experimental parameter was the CO₂ concentration, which was varied from 0 to 2 mol %. This parameter can be considered as a critical one, since experimental conditions must be

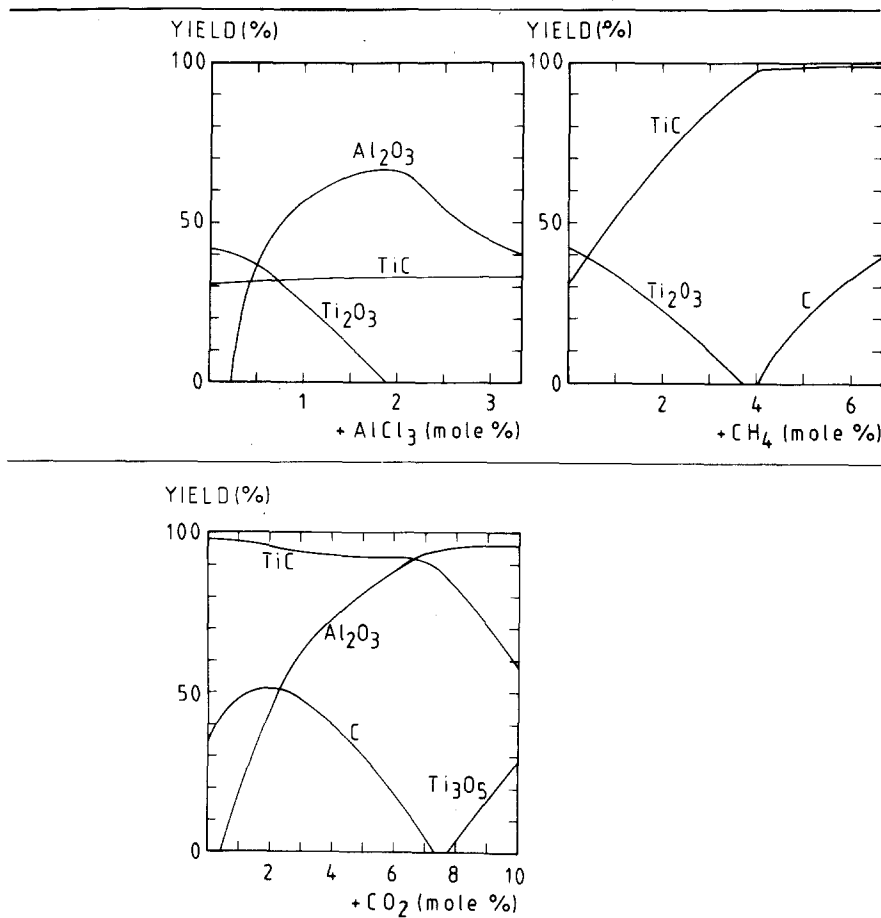


Figure 2 Thermodynamic calculations in the $\text{TiCl}_4\text{-AlCl}_3\text{-CH}_4\text{-CO}_2\text{-H}_2$ CVD systems. Influence of the AlCl_3 and CH_4 concentrations (in the presence of 3 mol % TiCl_4 and 1 mol % CO_2) and of the CO_2 concentration (in the presence of 3 mol % TiCl_4 , 3 mol % AlCl_3 and 6 mol % CH_4) on the yield of the deposited substances (1050°C, 65 mbar, hydrogen carrier gas).

$$Y(\text{TiC}) = \frac{\text{mole TiC eq}}{\text{mole TiCl}_4 \text{ in}} \times 100, \quad Y(\text{Al}_2\text{O}_3) = \frac{\text{mole Al}_2\text{O}_3 \text{ eq}}{\text{mole AlCl}_3 \text{ in}} \times 100,$$

$$Y(\text{C}) = \frac{\text{mole C eq}}{\text{mole CH}_4 \text{ in}} \times 100, \quad Y(\text{Ti}_2\text{O}_3) = 2 \times \frac{\text{mole Ti}_2\text{O}_3 \text{ eq}}{\text{mole TiCl}_4 \text{ in}} \times 100,$$

$$Y(\text{Ti}_3\text{O}_5) = 3 \times \frac{\text{mole Ti}_3\text{O}_5 \text{ eq}}{\text{mole TiCl}_4 \text{ in}} \times 100$$

found for which titanium oxidation is kept at an absolute minimum.

3.2. Substrates

The substrates used were

- (i) polycrystalline sintered corundum with a polished surface ($0.01 \mu\text{m}$ surface roughness)
- (ii) cemented carbides containing WC, TiC, TaC, NbC and Co uncoated or coated with $6 \mu\text{m}$ TiC (referred to below as “WC-Co” or “WC-Co/TiC”).

3.3. Adhesion test

For the characterization of the adhesion, the coatings were tested as follows. At the beginning the coated surface of the sample was simply scratched with a tungsten carbide needle by hand. However, observation with the light microscope or SEM did not permit the clear distinction between spalling off or simple grooving of the coated surface.

Thus it was necessary to rub a spherical crater through the coating by erosion using a steel ball and

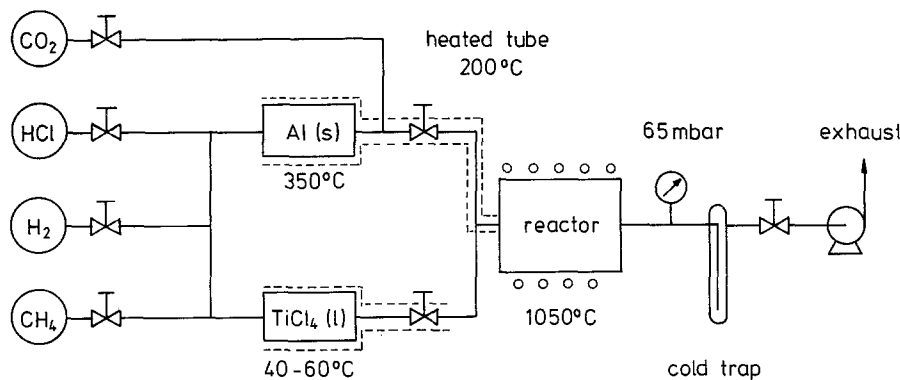


Figure 3 Schematic illustration of the apparatus used for deposition of $\text{Al}_2\text{O}_3\text{-TiC}$ multilayers and mixed layers.

TABLE I Influence of the gas phase and the substrate on the nature of the phases deposited by CVD from $\text{TiCl}_4\text{-CH}_4\text{-AlCl}_3\text{-CO}_2\text{-H}_2$ (gas mixtures hydrogen as carrier gas). 1050°C and 65 mbar total pressure.

Run	Composition of the gas phase (mol %)				Deposited phases depending on the nature of the substrate		
	TiCl_4	CH_4	AlCl_3	CO_2	$\alpha\text{-Al}_2\text{O}_3$	WC-Co/TiC	WC-Co
1	0	0	3	1	$\alpha\text{-Al}_2\text{O}_3$	$\alpha\text{-Al}_2\text{O}_3$	$\alpha\text{-Al}_2\text{O}_3$
2	3	0	3	1	$\alpha\text{-Al}_2\text{O}_3$	$\alpha\text{-Al}_2\text{O}_3$ TiC_xO_y	$\alpha\text{-Al}_2\text{O}_3$ TiC_xO_y
3	0	6	3	1	$\alpha\text{-Al}_2\text{O}_3$	$\kappa\text{-Al}_2\text{O}_3$	$\kappa\text{-Al}_2\text{O}_3$
4	3	6	0	0	TiC	TiC	TiC
5	3	6	3	0	TiC	TiC	TiC
6	3	6	3	0.5	TiC_xO_y	TiC_xO_y	$\alpha\text{-Al}_2\text{O}_3$ TiC_xO_y
7	3	6	3	0.7		$\alpha\text{-Al}_2\text{O}_3$	
8	3	6	3	1		+ TiC_xO_y	
9	3	6	3	2	$\alpha\text{-Al}_2\text{O}_3$		

a diamond suspension at the site where the scratch had been made earlier.

This procedure permitted the viewers, by examination with an optical microscope, to judge the quality of the adhesions (Fig. 4). It could be easily seen whether or not the layer had been removed by the tungsten carbide needle. A more detailed description of the ball cratering technique is in the literature [8, 9].

3.4. SEM

The morphologies of the coatings were examined by SEM after a sputtered deposition of a thin gold layer.

4. Results

4.1. X-ray diffraction analyses

Tables I and II indicate the solid phases deposited after the CVD reaction on each of the substrates for several gas phase compositions.

The comparison between runs 1 and 3 in Table I shows that 6 mol % CH_4 led to the formation of the $\kappa\text{-Al}_2\text{O}_3$ phase instead of the $\alpha\text{-Al}_2\text{O}_3$ phase.

However, on a pure $\alpha\text{-Al}_2\text{O}_3$ (corundum) substrate the κ -modification was never deposited. SEM images showed that on these substrates a perfect epitaxial growth of the α -alumina phase took place instead. While in the case of cemented carbide substrates methane obviously favoured the formation of $\kappa\text{-Al}_2\text{O}_3$, the epitaxial growth conditions forced the $\alpha\text{-Al}_2\text{O}_3$ (corundum) modification to grow on an $\alpha\text{-Al}_2\text{O}_3$ substrate.

It should be mentioned that $\alpha\text{-Al}_2\text{O}_3$ was also always observed if the high purity $\text{AlCl}_3\text{-CO}_2\text{-H}_2$ sys-

tem was applied on both cemented carbide and Al_2O_3 substrates. However, it is known that certain impurities can enhance the κ -alumina formation on cemented carbide substrates [10].

If during the Al_2O_3 deposition both methane and TiCl_4 are present (runs 6 to 9, see Table I) α -alumina is again the only phase to be formed on both substrates, showing that TiCl_4 stabilizes $\alpha\text{-Al}_2\text{O}_3$ more than $\kappa\text{-Al}_2\text{O}_3$. The reason for this is probably that Ti_2O_3 has the same crystal structure, trigonal scalenohedric, as $\alpha\text{-Al}_2\text{O}_3$.

In all cases where TiCl_4 and CO_2 were present simultaneously, even with low CO_2 concentrations, a cubic titanium oxycarbide phase was formed. Even the presence of AlCl_3 cannot prevent — by the formation of the stable Al_2O_3 — the incorporation of oxygen in the TiC. This, however, is not necessarily detrimental for the cutting properties of the tool: good wear resistance has been reported for titanium-oxycarbide layers by Kikuchi *et al.* [11, 12].

As shown in Table II, depending on the deposition conditions, two main Ti(C, O) compositions were formed. In all cases the oxygen-rich composition was observed if CO_2 was present. The carbon-rich composition could only be observed on substrates containing carbon, particularly in the WC-Co substrates without a TiC coating. Obviously and in accordance with Kikuchi *et al.* [12] carbon diffusion from the substrate enhances the carbon content of the Ti(C, O) phase.

The exact compositions of these oxycarbide phases are difficult to determine from the lattice parameters

TABLE II Influence of CO_2 concentration and substrate on the composition of the deposited titanium oxycarbide phases.

Substrate	CO_2 concentration in the gas phase (mol %)				
	0	0.5	0.7	1	2
$\alpha\text{-Al}_2\text{O}_3$	TiC	$\text{TiC}_{0.2}\text{O}_{0.8}$	$\text{TiC}_{0.2}\text{O}_{0.8}$	TiC_xO_y broad and weak peaks	not observed
WC-Co/TiC	TiC	$\text{TiC}_{0.65}\text{O}_{0.35}$ $\text{TiC}_{0.2}\text{O}_{0.8}$	$\text{TiC}_{0.2}\text{O}_{0.8}$	$\text{TiC}_{0.2}\text{O}_{0.8}$ broad and weak peaks	TiC_xO_y broad and very weak peaks
WC-Co	TiC	$\text{TiC}_{0.65}\text{O}_{0.35}$ $\text{TiC}_{0.2}\text{O}_{0.8}$	$\text{TiC}_{0.65}\text{O}_{0.35}$ $\text{TiC}_{0.2}\text{O}_{0.8}$	$\text{TiC}_{0.65}\text{O}_{0.35}$ $\text{TiC}_{0.2}\text{O}_{0.8}$	TiC_xO_y

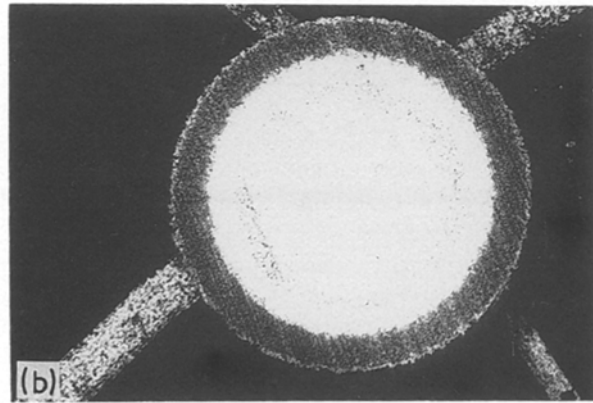
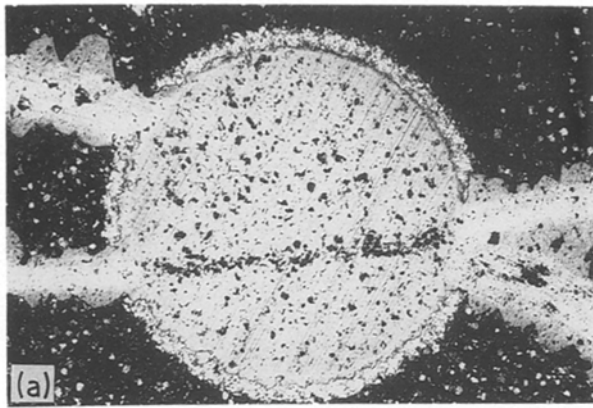


Figure 4 Adhesion test. (a) Pure TiC layer on pure Al_2O_3 substrate: poor adhesion. (b) $\text{TiC-Al}_2\text{O}_3$ composite layer on a WC-Co-TiC substrate: good adhesion.

as they are influenced by both elements, carbon and oxygen, and by the overall stoichiometry, which cannot be measured in a simple way. From the work of Neumann *et al.* [13] and with the assumption that stoichiometric compositions were reached, the main compositions should be $\text{TiC}_{0.65}\text{O}_{0.35}$ and $\text{TiC}_{0.2}\text{O}_{0.8}$ respectively.

The formation of the two different $\text{Ti}(\text{C}, \text{O})$ compositions can be interpreted as a result of two different carbon sources in the CVD system.

(1) The hard metal substrates and especially those not coated with TiC can deliver carbon by diffusion to the interface where deposition takes place.

(2) The methane in the gas phase is the second source of carbon.

According to this assumption, the carbon-rich compositions can be formed only if the two carbon sources act simultaneously, that is, if they deliver enough carbon for its stabilization. This did not occur at all on alumina substrates (see Table II).

From the work of Belon and Forestier [14], the determination of the lattice parameters allowed the evaluation of the titanium concentration in the $\alpha\text{-Al}_2\text{O}_3$ phase. The maximal Ti_2O_3 concentration in $\alpha\text{-Al}_2\text{O}_3$ is near 12.5 wt % [14]. In our experiments the titanium concentration in $\alpha\text{-Al}_2\text{O}_3$ was greater for higher CO_2 additions (Table III). This can be explained by the increased growth rates of the alumina in these cases. It is well known that a high growth rate favours the incorporation of trace impurities into a growing crystal [15, 16].

TABLE III Influence of the CO_2 concentration on the Ti_2O_3 content in the $\alpha\text{-Al}_2\text{O}_3$ phase

CO_2 (%)	lattice parameters of $\alpha\text{-Al}_2\text{O}_3$	Ti_2O_3 wt %
0.5	not measurable	
0.7	4.7603	$\approx 1\%$
1	4.7603	$\approx 1\%$
2	4.7652	$\approx 7\%$

4.2. Adhesion of the coatings

All coatings exhibited good adhesion on all substrates with one exception, the coating-substrate combination of a pure TiC coating on a pure and polished $\alpha\text{-Al}_2\text{O}_3$ substrate, which showed poor adhesion (see Fig. 4). This was surprising since SEM investigations showed that TiC grew epitaxially on the $\alpha\text{-Al}_2\text{O}_3$ substrates. Epitaxy is, therefore, not necessarily the only criterion for good adhesion of a coating. Other factors such as chemical compatibility or relative thermal expansion coefficients or monoatomic impurity layers are probably just as important. The results obtained in the present work show that, from the view-point of the adhesion only, it seems preferable to coat alumina with titanium oxycarbide rather than with pure TiC.

5. Microstructure of the coatings

A typical layer morphology is shown in Fig. 5. The TiC_xO_y and Al_2O_3 phases can be easily distinguished by EDX analyses. The Al_2O_3 grains have faceted hexagonal (0001) planes and a rough surface on the prismatic crystal faces. The mechanism of crystal growth is different depending on the orientation. The growth rates however remain similar in both crystal directions since no whiskers or needles are formed. The TiC_xO_y phase acts as a matrix for the alumina grains and is particularly fine grained.

5.1. Influence of the CO_2 concentration

Higher CO_2 concentrations provoke a higher Al_2O_3 nucleation frequency (Fig. 6). With 2% CO_2 small Al_2O_3 crystals touching each other to form a columnar structure are observed. The TiC_xO_y phase is present as a "binder" between the columnar alumina grains.

5.2. Influence of the carbon diffusion from the substrate on the coating formation

In order to study the influence of carbon diffusion from the substrate as well as the layer formation on three different substrates under methane-free deposition conditions in the gas phase (run 2, see Table I), the following three substrates were coated (see Fig. 7).

(1) $\alpha\text{-Al}_2\text{O}_3$ substrates: No carbon in the substrate; only a compact $\alpha\text{-Al}_2\text{O}_3$ coating containing titanium is formed.

(2) WC-Co substrates with a CVD TiC underlayer: The TiC layer acts as a diffusion barrier for the carbon from the cemented carbide substrates. $\alpha\text{-Al}_2\text{O}_3$ and TiC_xO_y grow in combined formations. The $\alpha\text{-Al}_2\text{O}_3$ grains are not agglomerated as in the case of the alumina substrate.

(3) WC-Co substrate: Carbon can diffuse easily from this substrate to the growing interface. The same phases as in (2) are formed, but the Al_2O_3 deposition

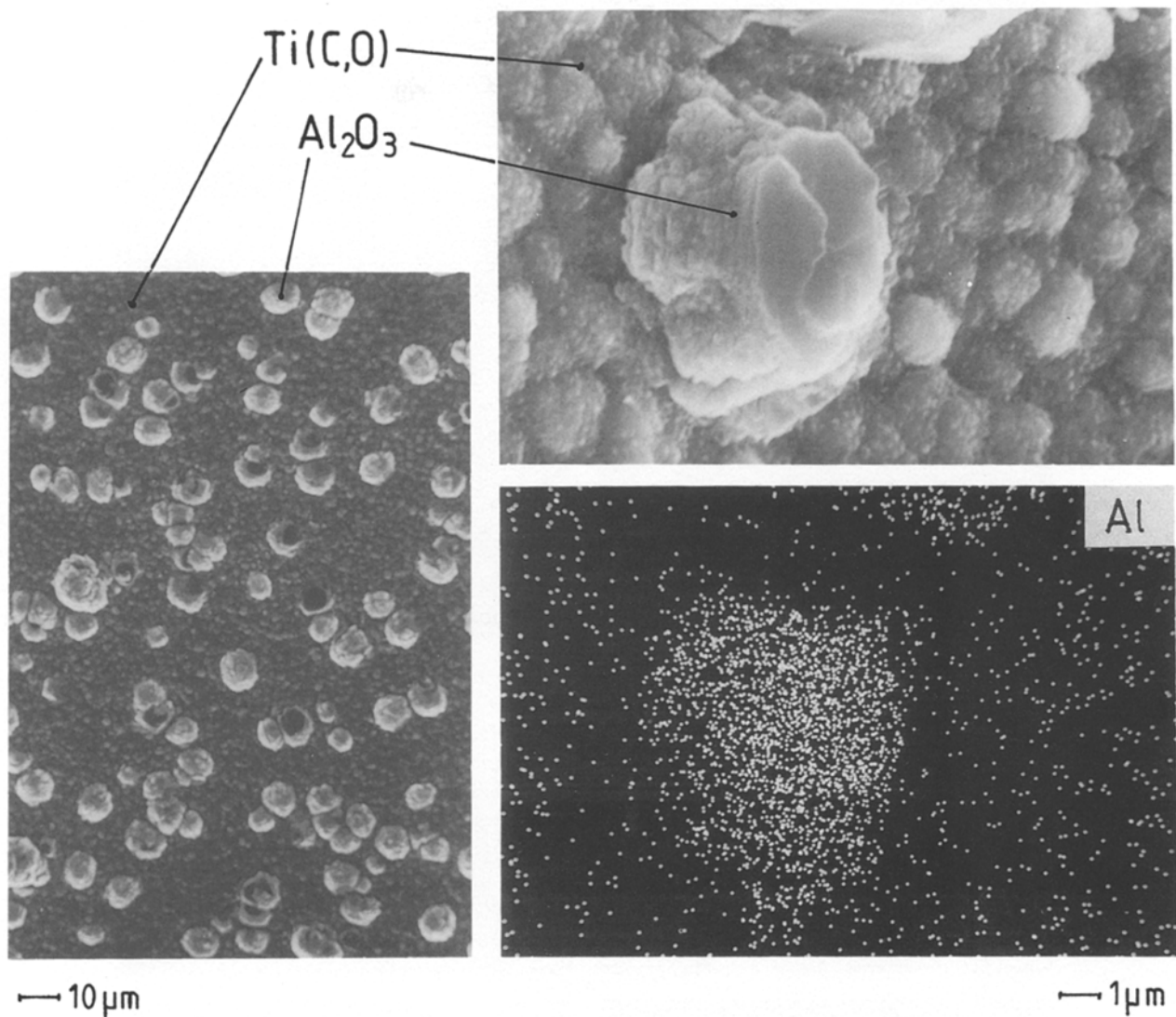


Figure 5 Typical mixed coating layer deposited from a complex $\text{TiCl}_4\text{-AlCl}_3\text{-CH}_4\text{-CO}_2\text{-H}_2$ environment. WC-Co substrate. The Al_2O_3 and TiC_xO_y phases can be easily distinguished by EDX analyses.

is more difficult due to the easier growth of the TiC_xO_y phase. The effect is an increase of the Ti(C, O) -“binder” and a greater distance between the Al_2O_3 grains.

This comparison shows that the morphology of the coating can be considerably influenced by the carbon activity of the substrate.

For long deposition times, the Al_2O_3 formation should become easier and the TiC_xO_y deposition more difficult. The result would be a progressive transition from a TiC_xO_y to an Al_2O_3 phase. The formation of a composition gradient along this coating could create an ideal adhesion condition for a thick alumina layer on a substrate.

5.6. Influence of CH_4 on the Al_2O_3 deposition

From Table I only the cases 1 and 3, where TiCl_4 was not present in the gas phase and where only Al_2O_3 phases are formed, are discussed.

It was shown in Section 4.1 that CH_4 leads to the formation of a $\kappa\text{-Al}_2\text{O}_3$ phase. Another important effect was the difference in morphology of the coatings on a cemented carbide substrate without a prior TiC-CVD coating (see Fig. 8). It is known that deposition

of alumina on an uncoated cemented carbide substrate is more difficult due to reactions of the cobalt binder with the gas environment, leading to the formation of volatile CoCl_2 [17, 18]. It was shown recently that the deposition of alumina layers on such cemented carbide substrates is easier if aluminium bromide or aluminium iodide were used instead of aluminium chloride as the aluminium-donor in the gas phase [18].

In the chloride environment, the volatile chloride impurities led to the growth of Al_2O_3 whiskers (Fig. 8a). Additional methane in the gas phase was in this case beneficial since a compact Al_2O_3 layer was the result (Fig. 8b). There are two possible reasons.

(1) Although CoCl_2 did not markedly influence the growth mode for the κ -alumina crystals, it did in the α -phase, leading to the formation of $\alpha\text{-Al}_2\text{O}_3$ needles.

(2) CH_4 decomposition increased the carbon activity in the cobalt phase at an early stage in the CVD. Since tungsten was also present in the cobalt-binder, precipitation of WC could occur. A very thin protective layer of WC at the cobalt-binder surface thus formed at an early stage of the CVD process, hindering the reaction between cobalt and the chlorides of the gas phase.

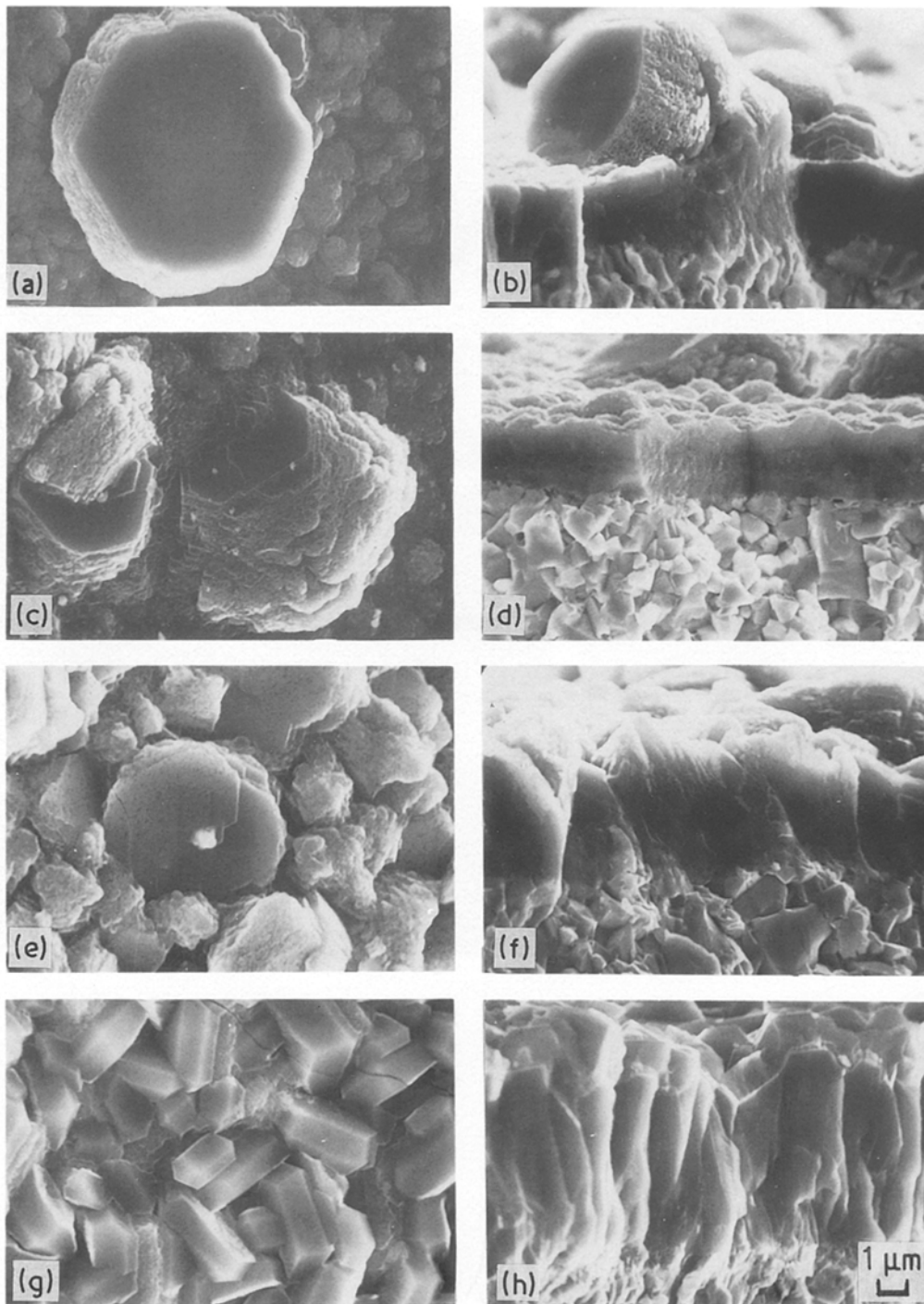


Figure 6 Influence of the CO₂ concentration on the coating morphology in the Al₂O₃-TiC CVD codeposition system at 1050° C and 65 mbar. AlCl₃-TiCl₄-CH₄-CO₂-H₂: 3-3-6-x-(88-x) mol %. (a) Surface 0.5 mol % CO₂, (b) fracture 0.5 mol % CO₂, (c) surface 0.7 mol % CO₂, (d) fracture 0.7 mol % CO₂, (e) surface 1 mol % CO₂, (f) fracture 1 mol % CO₂, (g) surface 2 mol % CO₂, (h) fracture 2 mol % CO₂.

6. Conclusion

Mixed compact CVD coatings can be deposited from AlCl₃-TiCl₄-CO₂-CH₄-H₂ gas phases at 1050° C and 65 mbar total pressure. The coatings consist of relatively large, faceted α-Al₂O₃ crystals containing some titanium and surrounded by a fine grained titanium oxycarbide matrix. Two main titanium-oxycarbide compositions were found. Their formation depends on the nature of the carbon donor. If only CH₄ acts as a carbon source, a TiC_{0.2}O_{0.8} phase is formed. If the carbon is delivered by diffusion from the substrate, a TiC_{0.65}O_{0.35} phase is formed.

As carbon diffusion from the substrate decreases, with increasing coating thickness more and more of

the alumina deposit is formed. It therefore seems possible to obtain a progressive transition from a TiC to an Al₂O₃ deposition, thus creating optimal adhesion conditions between a thick coating and the substrate.

It is confirmed that CH₄ in an AlCl₃-CO₂-H₂ environment stabilizes the κ-Al₂O₃ phase, which can be deposited as a compact layer without whisker formation on a WC-Co substrate even without a TiC underlayer.

Acknowledgements

The authors thank Sandvik AB, Stockholm for supplying specimens, for helpful discussions to members of the R&D team of the Coromant division and the

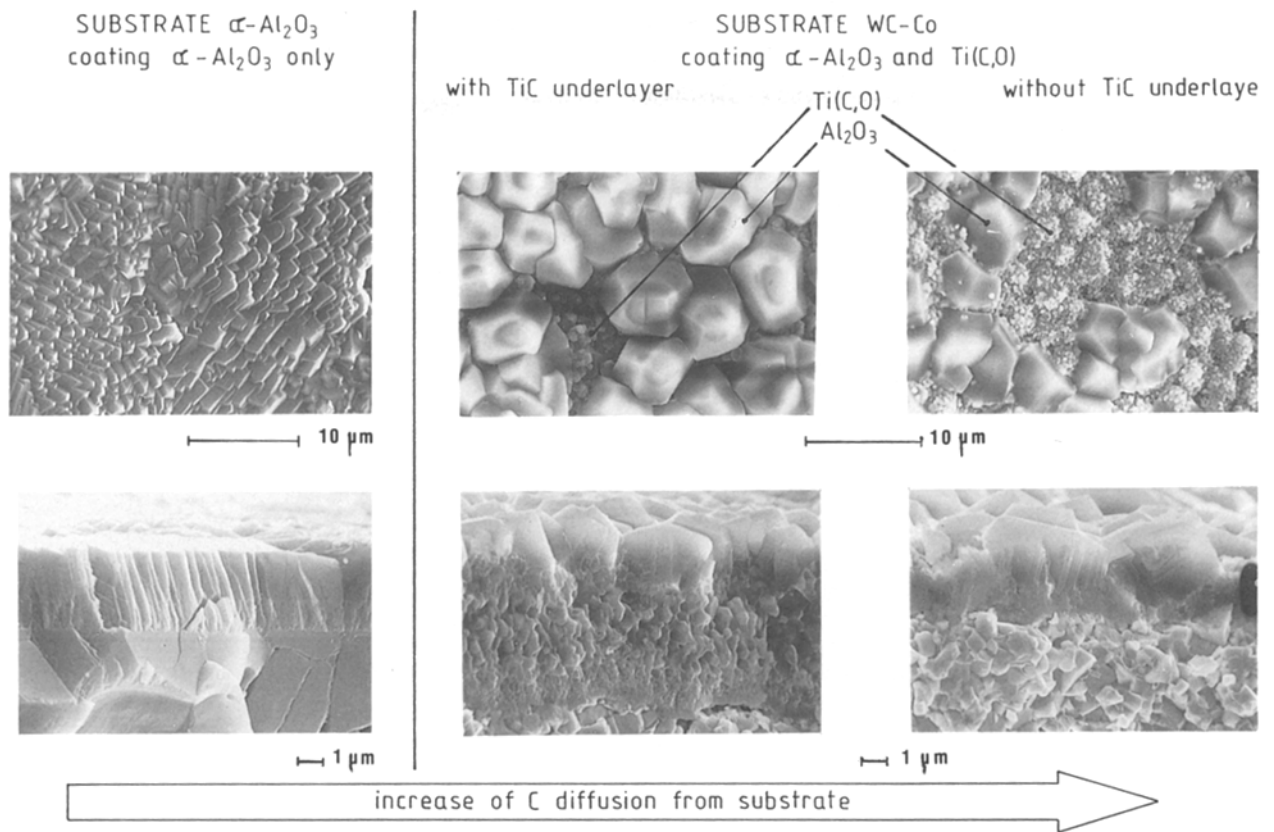


Figure 7 Influence of the carbon diffusing from the substrate on the Al₂O₃-TiC_xO_y coating morphology. Methane was not present in the gas phase. AlCl₃-TiCl₄-CO₂-H₂: 3-3-1-93 mol %.

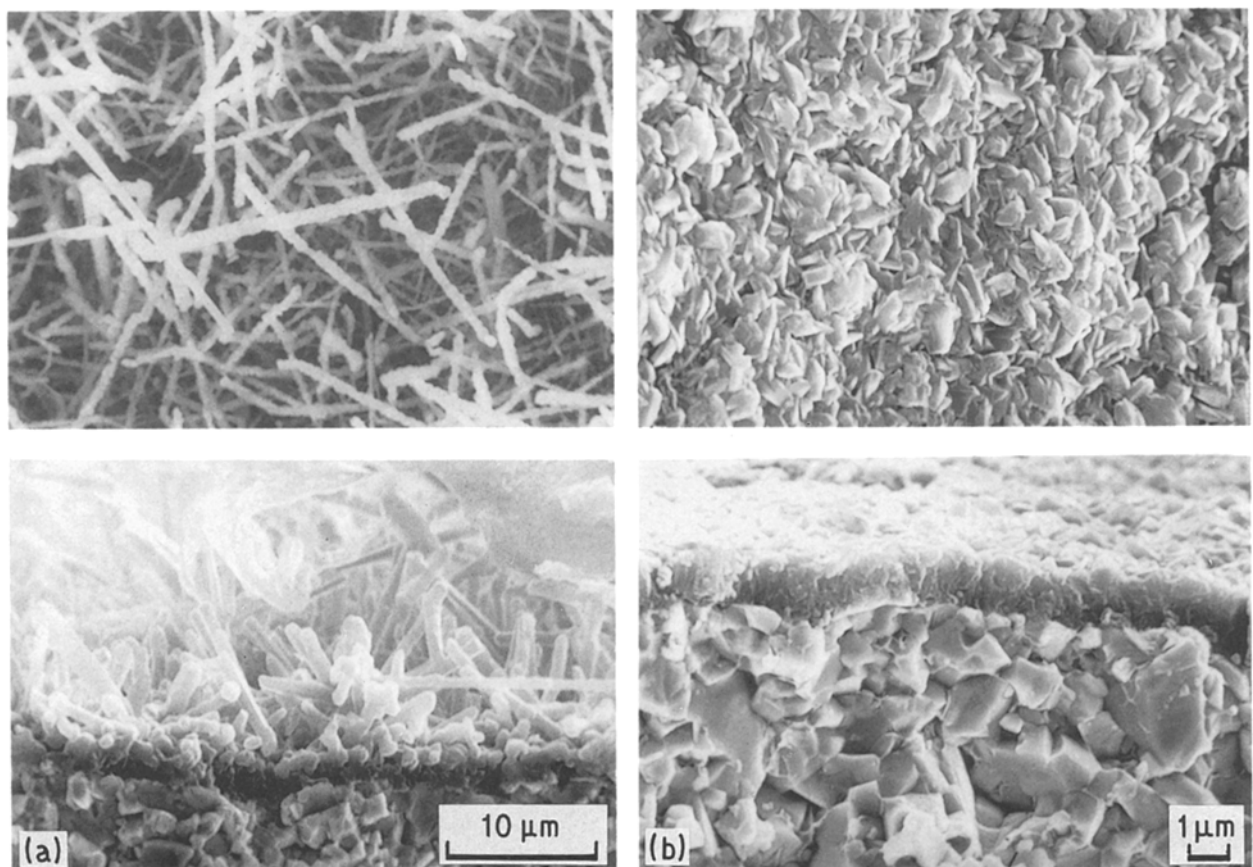


Figure 8 Influence of CH₄ on the Al₂O₃ CVD deposition. WC-Co substrate. (a) Absence of CH₄: formation of α -alumina needle crystals (b) presence of CH₄: formation of a compact κ -Al₂O₃ layer.

Austrian National Board for the Advancement of Research (Fonds zur Förderung der Wissenschaftlichen Forschung) for financial support under project S4312.

References

1. B. LUX, C. COLOMBIER, H. ALTENA and K. STJERNBERG, *Thin Solid Films* **138** (1984) 49.
2. D. STINTON, W. LACKEY, R. LAUF and T. BESMANN, *Ceram. Eng. Sci. Proc.* **5** (1984) 668-76.
3. T. HIRAI, T. GOTO and T. SAKARI, Emergent Process Methods for High Technology Ceramics, R. Davis, H. Palmour and R. Porter (Eds) (Plenum Press, New York, 1982) pp. 347-358.
4. T. BESMANN, *J. Amer. Ceram. Soc.* **69** (1986) 68-74.
5. B. NOLÄNG, Proceedings of the 5th European Conference on CVD, Uppsala, 107 (1985).
6. C. COLOMBIER, PhD thesis, Technical University of Vienna (1984).
7. L. VANDENBULK, Proceedings 8th International Conference on CVD, the Electrochemical Society, Pennington, 3 (1981).
8. H. BOVING and R. ROCCHI, 53. eme Congress Soc. Suisse de Chronometrie, La Chaux de Fonds, 507 (1978).
9. C. COLOMBIER, B. LUX, A. RIAHI, M. PUCHHAMMER and H. STÖRI, *Anal. Fresenius Z. Chem.* **329** (1987) 355-360.
10. J. LINDSTRÖM and U. SMITH, European Patent 0045291 A1, July (1981).
11. N. KIKUCHI, Y. LYZUKI, T. SUGIZAWA and F. WASHIZU, US Patent 4 341 834 (1982).
12. N. KIKUCHI, H. DOI and T. ONISHI, Proceedings 6th International Conference on CVD, 403 (1977).
13. G. NEUMANN, R. KIEFFER and P. ETTMAYER, *Monatshefte für Chemie* **103** (1972) 1130.
14. L. BELON and H. FORESTIER, *C. R. Acad. Sci. Paris* **258** (1964) 4282.
15. V. G. SMITH, W. A. TILLER and J. W. RUTTER, *Can. J. Phys.* **33** (1955) 723.
16. C. FLEMINGS, "Solidification Processing" (McGraw-Hill, New York, 1974) p. 55.
17. H. ALTENA, C. COLOMBIER, A. LEBL, J. LINDSTRÖM and B. LUX, Euro CVD 4, edited by J. Bloem, G. Verspui and L. Wolff, Eindhoven, 428 (1983).
18. C. COLOMBIER, J. PENG, H. ALTENA and B. LUX, *Int. J. Refr. Hard Metals* **5** (1986) 82.

Received 19 January
and accepted 1 June 1988